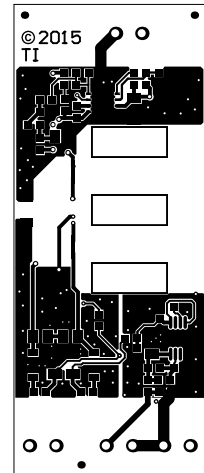


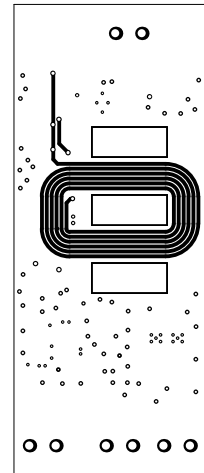
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 08.12.2015 10:27:03	TEXAS INSTRUMENTS	



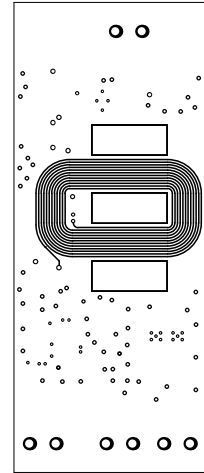
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 08.12.2015 10:27:06	TEXAS INSTRUMENTS	



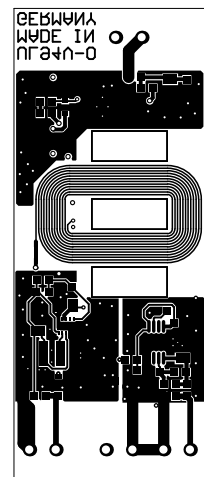
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 08.12.2015 10:27:10	TEXAS INSTRUMENTS	



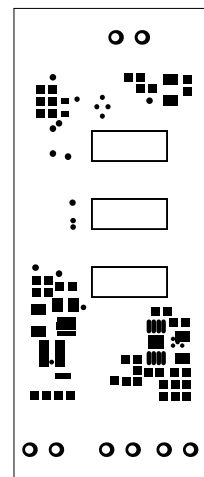
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer1	GENERATED : 08.12.2015 10:27:14	TEXAS INSTRUMENTS	



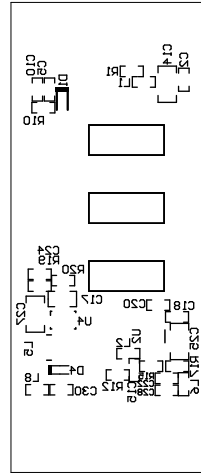
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer2	GENERATED : 08.12.2015 10:27:17	TEXAS INSTRUMENTS	



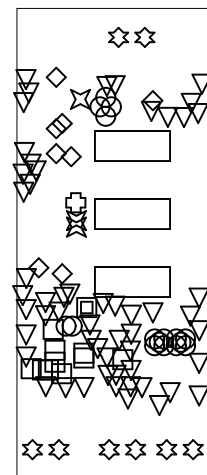
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 08.12.2015 10:27:21	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 08.12.2015 10:27:25	TEXAS INSTRUMENTS	

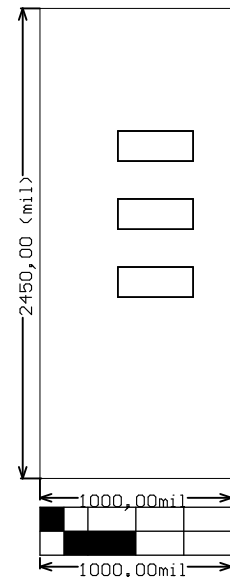


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 08.12.2015 10:27:29	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	16	7,87mil (0,200mm)	PTH	Round
□	10	8,00mil (0,203mm)	PTH	Round
■	1	10,00mil (0,254mm)	PTH	Round
⊠	3	11,81mil (0,300mm)	PTH	Round
▽	55	12,00mil (0,305mm)	PTH	Round
⊕	1	15,75mil (0,400mm)	PTH	Round
◇	8	17,72mil (0,450mm)	PTH	Round
☆	8	43,31mil (1,100mm)	PTH	Round
	102 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 08.12.2015 10:27:32	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 08.12.2015 10:27:36	TEXAS INSTRUMENTS	

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